Power Resistor Thick Film Technology

FEATURES
- 50 W at 25 °C case temperature heatsink mounted
- Direct mounting ceramic on heatsink
- Broad resistance range: 0.010 Ω to 550 kΩ
- Non inductive
- TO-220 package: Compact and easy to mount
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESIGN SUPPORT TOOLS

LTO series are the extension of RTO types. We used the direct ceramic mounting design (no metal tab) of our RCH power resistors applied to semiconductor packages.

DIMENSIONS in millimeters

<table>
<thead>
<tr>
<th>MODEL</th>
<th>SIZE</th>
<th>RESISTANCE RANGE Ω</th>
<th>RATED POWER P25 °C W</th>
<th>LIMITING ELEMENT VOLTAGE UL V</th>
<th>TOLERANCE ± %</th>
<th>TEMPERATURE COEFFICIENT ± ppm/°C</th>
<th>CRITICAL RESISTANCE Ω</th>
</tr>
</thead>
<tbody>
<tr>
<td>LTO 50</td>
<td>TO-220</td>
<td>0.010 to 550K</td>
<td>50</td>
<td>500</td>
<td>1, 2, 5, 10</td>
<td>150, 250, 700, 900</td>
<td>5K</td>
</tr>
</tbody>
</table>

MECHANICAL SPECIFICATIONS
- Mechanical Protection: Molded
- Resistive Element: Thick film
- Substrate: Alumina
- Connections: Tinned copper
- Weight: 2 g max.
- Mounting Torque: 1 Nm

TECHNICAL SPECIFICATIONS
- Dissipation and Associated: Onto a heatsink
- Power Rating and Thermal Resistance of the Component: 50 W at +25 °C (case temp.)
  \[ R_{TH,j-c} = 2.5 \, °C/W \] (free air: 2.5 W at +25 °C)
- Temperature Coefficient: See Performance table ± 150 ppm/°C
- Dielectric Strength Standard: MIL STD 202
  \[ V_{rms} = 1 \text{ min} \] (10 mA max.)
- Insulation Resistance: \( \geq 10^4 \, \text{MΩ} \)
- Inductance: \( \leq 0.1 \, \text{μH} \)

ENVIRONMENTAL SPECIFICATIONS
- Temperature Range: -55 °C to +150 °C
- Climatic Category: 55 / 155 / 56
- Flammability: IEC 60695-11-5 2 applications 30 s separated by 60 s

Note
- Tolerances unless stated: ± 0.3 mm
**PERFORMANCE**

<table>
<thead>
<tr>
<th>TESTS</th>
<th>CONDITIONS</th>
<th>REQUIREMENTS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Momentary Overload</td>
<td>EN 60115-1</td>
<td>± (0.5 % + 0.005 Ω)</td>
</tr>
<tr>
<td></td>
<td>1.5 Pr / 5 s</td>
<td></td>
</tr>
<tr>
<td></td>
<td>$U_o &lt; 1.5 U_L$</td>
<td></td>
</tr>
<tr>
<td>Rapid Temperature Change</td>
<td>EN 60115-1</td>
<td>± (0.5 % + 0.005 Ω)</td>
</tr>
<tr>
<td></td>
<td>IEC 60068-2-14 Test Na</td>
<td></td>
</tr>
<tr>
<td></td>
<td>5 cycles</td>
<td></td>
</tr>
<tr>
<td></td>
<td>-55 °C to +155 °C</td>
<td></td>
</tr>
<tr>
<td>Load Life</td>
<td>EN 60115-1</td>
<td>± (1 % + 0.005 Ω)</td>
</tr>
<tr>
<td></td>
<td>1000 h Pr at +25 °C</td>
<td></td>
</tr>
<tr>
<td>Humidity (Steady State)</td>
<td>MIL-STD-202 method 103 B cond. D</td>
<td>± (0.5 % + 0.005 Ω)</td>
</tr>
<tr>
<td>Vibration</td>
<td>MIL-STD-202 method 204 cond. D</td>
<td>± (0.2 % + 0.005 Ω)</td>
</tr>
<tr>
<td>Terminal Strength</td>
<td>MIL-STD-202 method 211 cond. A1</td>
<td>± (0.2 % + 0.005 Ω)</td>
</tr>
<tr>
<td>Shock</td>
<td>100G, MIL-STD-202 method 213 cond. I</td>
<td>± (0.5 % + 0.005 Ω)</td>
</tr>
</tbody>
</table>

**SPECIAL FEATURES**

<table>
<thead>
<tr>
<th>Resistance Values</th>
<th>≥ 0.010</th>
<th>≥ 0.015</th>
<th>≥ 0.1</th>
<th>≥ 0.5</th>
</tr>
</thead>
<tbody>
<tr>
<td>Tolerances</td>
<td>± 1 % at ± 10 %</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Typical Temperature Coefficient (-55 ° to +155 °C)</td>
<td>± 900 ppm/°C</td>
<td>± 700 ppm/°C</td>
<td>± 250 ppm/°C</td>
<td>± 150 ppm/°C</td>
</tr>
</tbody>
</table>

**CHOICE OF THE HEATSINK**

The user must choose according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed 150 °C. The dissipated power is simply calculated by the following ratio:

$$P = \frac{\Delta T}{R_{TH(j-c)} + R_{TH(c-h)} + R_{TH(h-a)}} \quad (1)$$

$P$: Expressed in W

$\Delta T$: Difference between maximum working temperature and room temperature

$R_{TH(j-c)}$: Thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal resistance of the component.

$R_{TH(c-h)}$: Thermal resistance value measured between outer side of the resistor and upper side of the heatsink. This is the thermal resistance of the interface (grease, thermal pad), and the quality of the fastening device.

$R_{TH(h-a)}$: Thermal resistance of the heatsink.

**Example:**

$R_{TH(c-h)}$ for LTO 50 power rating 10 W at ambient temperature +25 °C

Thermal resistance $R_{TH(j-c)}$: 2.5 °C/W

Considering equation (1) we have:

$$\Delta T = 150 \, ^\circ C - 25 \, ^\circ C = 125 \, ^\circ C$$

$$R_{TH(j-c)} + R_{TH(c-h)} + R_{TH(h-a)} = \frac{\Delta T}{P} = \frac{125}{10} = 12.5 \, ^\circ C/W$$

$$R_{TH(c-h)} + R_{TH(h-a)} = 12.5 \, ^\circ C/W - 2.5 \, ^\circ C/W = 10 \, ^\circ C/W$$

with a thermal grease $R_{TH(c-h)} = 1 \, ^\circ C/W$, we need a heatsink with $R_{TH(h-a)} = 9 \, ^\circ C/W$. 
**OVERLOADS**

In any case the applied voltage must be lower than the maximum overload voltage of 750 V.

The values indicated on the graph below are applicable to resistors in air or mounted onto a heatsink.

**ENERGY CURVE**

![Energy Curve Graph]

**POWER CURVE**

![Power Curve Graph]

**POWER RATING**

The temperature of the case should be maintained within the limits specified.

To improve the thermal conductivity, surfaces in contact should be coated with a silicone grease and the torque applied on the screw for tightening should be around 1 Nm.

**PACKAGING**

Tube of 50 units

**MARKING**

Model, style, resistance value (in Ω), tolerance (in %), manufacturing date, Vishay Sfernice trademark.
**ORDERING INFORMATION**

<table>
<thead>
<tr>
<th>MODEL</th>
<th>STYLE</th>
<th>CONNECTIONS</th>
<th>RESISTANCE VALUE</th>
<th>TOLERANCE</th>
<th>CUSTOM DESIGN</th>
<th>PACKAGING</th>
<th>LEAD (Pb)-FREE</th>
</tr>
</thead>
<tbody>
<tr>
<td>LTO</td>
<td>50</td>
<td>F</td>
<td>2.7 kΩ</td>
<td>± 1 %</td>
<td>optional</td>
<td>TU50</td>
<td>e3</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>± 1 %</td>
<td>on request:</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>± 2 %</td>
<td>special TCR,</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>± 5 %</td>
<td>shape etc.</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>± 10 %</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**GLOBAL PART NUMBER INFORMATION**

<table>
<thead>
<tr>
<th>GLOBAL MODEL</th>
<th>SIZE</th>
<th>LEADS</th>
<th>OHMIC VALUE</th>
<th>TOLERANCE</th>
<th>PACKAGING</th>
<th>LEAD (Pb)-FREE</th>
</tr>
</thead>
<tbody>
<tr>
<td>LTO 050 F</td>
<td>050</td>
<td>F = radial leads</td>
<td>The first four digits are significant figures and the last digit specifies the number of zeros to follow. R designates decimal point. 48R70 = 48.7 Ω 48701 = 48 700 Ω 10002 = 100 000 Ω R0100 = 0.01 Ω R4700 = 0.47 Ω 27000 = 2700 Ω = 2.7 kΩ</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**RELATED DOCUMENTS**

**APPLICATION NOTES**

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